

# 3-Amino-3-(2-chlorophenyl)propionic acid, N-dimethylaminomethylene-, ethyl ester

Inchi:	InChI=1S/C14H19CIN2O2/c1-4-19-14(18)9-13(16-10-17(2)3)11-7-5-6-8-12(11)15/h5-8,10
InchiKey:	KPCDELOTIFFKIP-UHFFFAOYSA-N
Formula:	C14H19CIN2O2
SMILES:	CCOC(=O)CC(N=CN(C)C)c1ccccc1Cl
Mol. weight [g/mol]:	282.77

## Physical Properties

Property code	Value	Unit	Source
hf	-223.30	kJ/mol	Joback Method
hvap	68.21	kJ/mol	Joback Method
log10ws	-3.02		Crippen Method
logp	2.924		Crippen Method
mcvol	219.700	ml/mol	McGowan Method
pc	1832.54	kPa	Joback Method
rinpol	1961.00		NIST Webbook
rinpol	1961.00		NIST Webbook
tb	753.78	K	Joback Method
tc	972.38	K	Joback Method

## Sources

Joback Method:	<a href="https://en.wikipedia.org/wiki/Joback_method">https://en.wikipedia.org/wiki/Joback_method</a>
McGowan Method:	<a href="http://link.springer.com/article/10.1007/BF02311772">http://link.springer.com/article/10.1007/BF02311772</a>
NIST Webbook:	<a href="http://webbook.nist.gov/cgi/cbook.cgi?ID=U375832&amp;Units=SI">http://webbook.nist.gov/cgi/cbook.cgi?ID=U375832&amp;Units=SI</a>
Crippen Method:	<a href="http://pubs.acs.org/doi/abs/10.1021/ci9903071">http://pubs.acs.org/doi/abs/10.1021/ci9903071</a>
Crippen Method:	<a href="https://www.chemeo.com/doc/models/crippen_log10ws">https://www.chemeo.com/doc/models/crippen_log10ws</a>

## Legend

hf:	Enthalpy of formation at standard conditions
hvap:	Enthalpy of vaporization at standard conditions

<b>log10ws:</b>	Log10 of Water solubility in mol/l
<b>logp:</b>	Octanol/Water partition coefficient
<b>mvol:</b>	McGowan's characteristic volume
<b>pc:</b>	Critical Pressure
<b>rinpol:</b>	Non-polar retention indices
<b>tb:</b>	Normal Boiling Point Temperature
<b>tc:</b>	Critical Temperature

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